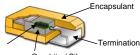
KEMET Surface Mount Tantalum

Revision H. 11 March 2008

Note: Information subject to change without notice. Monitor website regularly for updates. KEMET is not liable for any damages, direct or indirect, consequential or otherwise, that the reader might incur as a result of ignoring this warning, or that any third party might suffer as a result of the reader's ignoring this warning.

Characteristics and Typical Construction

- · Variety of features by series
- Pb-Free & RoHS / ELV Compliant version standard
- 3 50 Volts
- ± 20% Capacitance tolerance
- Tape & Reel Packaging



Tantalum | Graphite / Silver | Counterelectrode

RoHS Restricted Substance Content

Key for Determining Adherence to China RoHS and EU 2002/95/EC and 2005/618/EC Content Criteria
O = \leq MCV, X = > MCV, X = > MCV, but EU RoHS Compliant with Exemption(s)

			Restricted Material					Compliant Version			
	<u> </u>	Material and MCV ¹ Termination	Cd	Cr ⁶⁺	Pb	Hg	PBB	PBDE	Available since	Standard since	China RoHS Symbol ²
KEMET Product	Series	Code	< 0.01%	< 0.1%	< 0.1%	< 0.1%	< 0.1%	< 0.1%			2,
Precision Molded Chip	T491	T or G	0	0	0	0	0	0	Mar-00	n/a - Termination unique for Pb-Free	©
Low ESR, Industrial Grade	T494										
Low ESR, Surge Robust	T495										
Fail Safe Fused	T496										
High Grade COTS	T497										
High Temperature Tantalum	T498, T499										
Ultra-Low ESR	T510										
Precision Molded Chip	T491	Н	0	0	X	0	0	0			
Low ESR, Industrial Grade	T494										
Low ESR, Surge Robust	T495										
Fail Safe Fused	T496										(3)
High Grade COTS	T497										
Ultra-Low ESR	T510										
T492	T402	S	0	0	X	0	0	0			(3)
	1492	G	0	0	0	0	0	0	Mar-00	n/a - Termination unique for Pb-Free	(a)
Style CWR11 per MIL-PRF-55365/8	T409 (CWR09),		0	0	0	О	0	0	May-06	n/a - Termination unique for Pb-Free	@
	T419 (CWR19), T429 (CWR29)	Solder options per catalog	0	0	Х	0	0	0			6
Commercial-Off-The-Shelf (COTS)	T493	T or B	0	0	0	0	0	0	Oct-05	n/a - Termination unique for Pb-Free	@
		Solder options per catalog	0	0	Х	0	0	0			6

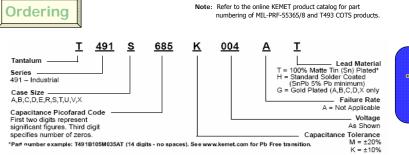
¹MCV = Maximum Concentration Values per 2005/618/EC amending RoHS Directive 2002/95/EC and China RoHS criteria.

China RoHS Symbol based on current manufacturing. Refer to notes in Pb column for transition dates.

Soldering Capability Characteristics

	Matte Tin Termination	SnPb Termination
Termination Material	Copper	Copper
Termination Plating (Barrier)	100% Matte Tin (Copper, Nickel)	90Sn10Pb (Copper)
Peak Temperature Capability	260°C	260°C
Soldering Process Compatibility	Backward & Forward Compatible	Backward & Forward Compatible
MSL Rating	1	1
Tin Whisker Test Results	Class 2	Class 2
based on JESD22-A121 and JESD201 ⁵		

Per EIA/ECA component bulletin CB19, tin whiskering is not considered a reliability risk within the capacitor industry for non-Military / Hi-Rel applications.









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B45197-A2157-M509 B45197A5226M409 CWR09JC105KCB\M100 CWR11CH107KBA TCSCS1A336KBAR 419-2060-501 B45196-H5106-K309 B45196-H6226-K509 CWR29JC106KBEZ T83D475K050RCCL 591D158X06R3R2T20H M39006/22-0640H M39003/01-2596 TCSCS1A476KBAR T83E107K016RCCL T83D685K035RCCL 293D475X0035B2DE3 TMCMB1C475KTRF 293D155X9020A2DE3 298W476X06R3M2T 298W107X0004M2T CWR29NC225KDFC CWR29HH155KCBB 293D476X9035E2TE3 CWR29KC226JCGC T513X227K016BH4585 T97H107M040HSA 595D686X9010B2T T25D337M016CSZ 591D156X9025R8T15H 594D686X9016C2T 595D106X0025C8T CWR29DC226KBDA\TR CWR29FC106KBBA\TR CWR29FC686KBGA\TR CWR29FC157KBXA\TR CWR29HC105KBAA\TR CA55-B6R3M107T CA55-E025M107T TC212B475K035Y TAZH685K035LBSB0824 TAZG107K010LBSB0800 TAZH475K050LBSB0H23 TAZH156K025CBSZ0824 TBJD156K025CBSZ0824 TMCSA1V154MTRF TMCSA0J225MTRF TMCSA1D684MTRF TMCSA1E474MTRF